



# MICROCHIP PIC16F631/677/685/687/689/690

## PIC16F631/677/685/687/689/690 Rev. A Silicon/Data Sheet Errata

The PIC16F631/677/685/687/689/690 parts you have received conform functionally to the Device Data Sheet (DS41262C), except for the anomalies described below.

All of the issues listed here will be addressed in future revisions of the PIC16F631/677/685/687/689/690 silicon.

### 1. Module: EUSART (PIC16F687/689/690 only)

#### 1.1 WUE Bit is not clearing.

After a wake-up due to a Break character, the WUE bit is not automatically cleared.

##### Work around

Clear the WUE bit after waking up.

##### Fix

Rev. A5 Silicon and later revisions.

#### 1.2 Auto-baud captures the incorrect baud rate after a break.

The SPBRGH:SPBRG registers are not being initialized correctly. If WUE and ABDEN are set at the same time and a Break character followed by a Sync character are received, then the calculated baud rate will be random.

##### Work around

Set WUE and wait for the wake-up to occur.

Clear SPBRGH:SPBRG after waking up with the break.

Set ABDEN to begin the auto-baud process.

##### Fix

Rev. A5 Silicon and later revisions.

#### 1.3 Auto-baud calculates a baud rate value that is +2.

The SPBRGH:SPBRG are not initialized correctly when ABDEN is set. This causes the measured baud rate to be high by two counts.

##### Work around

Clearing the SPBRGH:SPBRG registers will correctly initialize the baud rate counter. After the auto-baud has been completed, the baud rate will now be +1. The firmware should now subtract 1 from the baud rate generator to produce the correct baud rate.

##### Fix

Rev. A5 Silicon and later revisions.

#### 1.4 Delay after auto-baud before transmit is allowed.

After the auto-baud Sync character has been received and the RCIF flag is set, there is approximately 17 ms of delay before the transmitter is enabled.

##### Work around

After the RCIF flag is set indicating the baud rate has been measured, read the SPBRG register and write the value back to SPBRG. This will terminate the delay, and enable the transmitter module.

##### Fix

Rev. A5 Silicon and later revisions.

#### 1.5 Auto-baud sequence cannot be aborted in some cases.

If an auto-baud is started but no edges are received, there is no way to leave Auto-Baud mode.

##### Work around

Use the Watchdog Timer to reset the entire device.

##### Fix

Rev. A5 Silicon and later revisions.

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## 1.6 Clearing SPEN does not reset EUSART state machine correctly.

When SPEN is cleared, the entire EUSART is frozen. When SPEN is set, the EUSART resumes where it left off. This can cause some unexpected behavior.

### Work around

To reset the EUSART, toggle TXEN and CREN after clearing SPEN. This will reset the transmit and receive state machines.

### Fix

Rev. A5 Silicon and later revisions.

## 1.7 Extra character transmitted after auto-baud.

If TXEN is high when ABDEN is set, it will be cleared as soon as the auto-baud process begins, and reset as soon as the auto-baud process completes. When TXEN is reset, the character in the transmit queue will be transmitted.

### Work around

Before starting auto-baud, clear TXEN. This will reset the transmit state machine correctly. After the auto-baud is complete and the firmware has brought TXEN high, no character will be transmitted.

### Fix

Rev. A5 Silicon and later revisions.

## 2. Module: SSP (PIC16F687/689/690 only)

In any of the I<sup>2</sup>C™ modes, the SSP module will fail to recognize the first Start bit received after a transition from module disable to module enable. Subsequent Stop bits and Start bits are detected properly.

### Work around

Enable the SSP module in SSPMSK Access mode before changing the mode to the desired I<sup>2</sup>C operation.

### EXAMPLE 1: CODE EXAMPLE

```
MOVLW B'00111001' ;Module enable, clock
MOVWF SSPCON      ;enable, SSPMSK access.
                  ;Optionally load
                  ;address mask value
                  ;into SSPMSK register.
MOVLW B'00110110' ;Module enable, clock
MOVWF SSPCON      ;enable, 7-bit address
                  ;I2C slave.
```

## 3. Module: ECCP with Auto-Shutdown (Silicon Rev. A4 and previous revisions) (PIC16F685 and PIC16F690 only)

The PIC16F631/677/685/687/689/690 Rev. A4 silicon for the ECCP Auto-Shutdown is connected to the C1IF and C2IF flags. See Figures 8-2 and 8-3 on the following page.

The auto-shutdown connection (Rev. A4 and previous) to C1IF and C2IF causes the auto-shutdown to incorrectly operate synchronously. Additionally, reads of CMxCON0 will incorrectly clear an auto-shutdown event.

### Work around

Rev. A4 Silicon and previous revisions.

- 1) Poll the CxOUT bit until it is low.
- 2) Read CMxCON0 to precondition CxIF.
- 3) If CMxCON0 is read while CxOUT is changing, repeat steps 1 and 2.

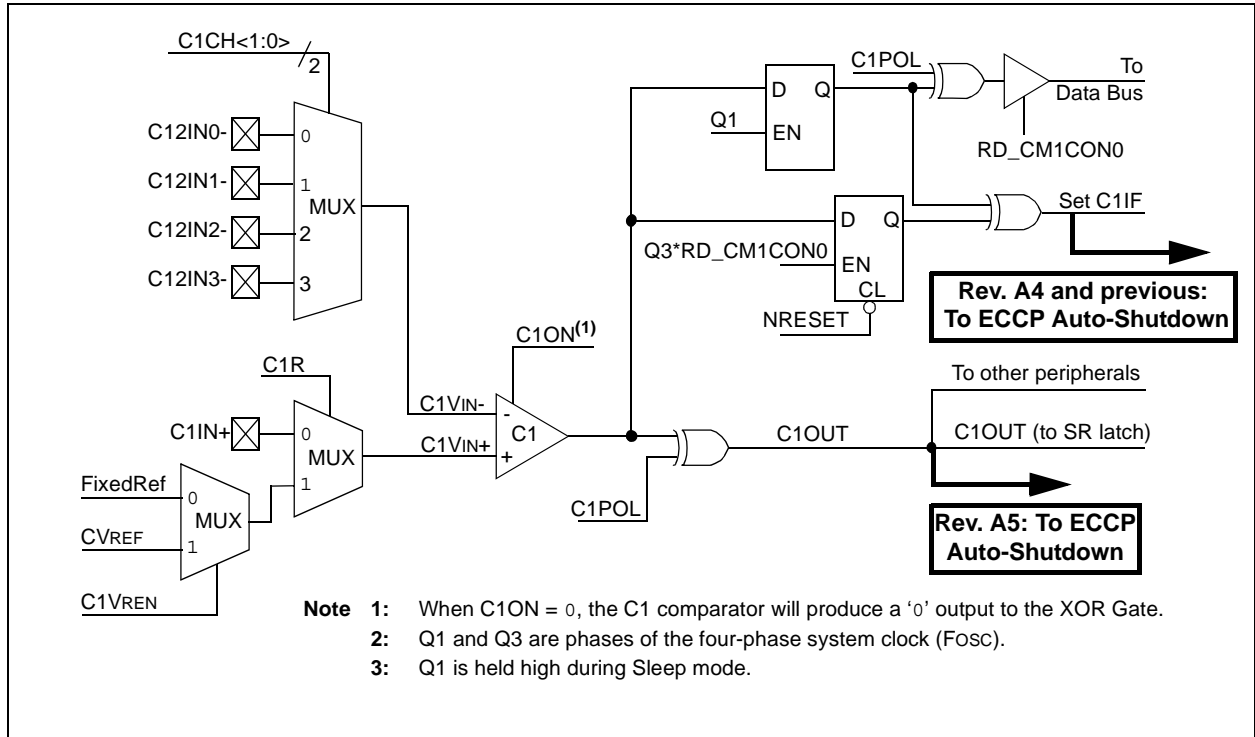
### Fix

Rev. A5 Silicon and later revisions.

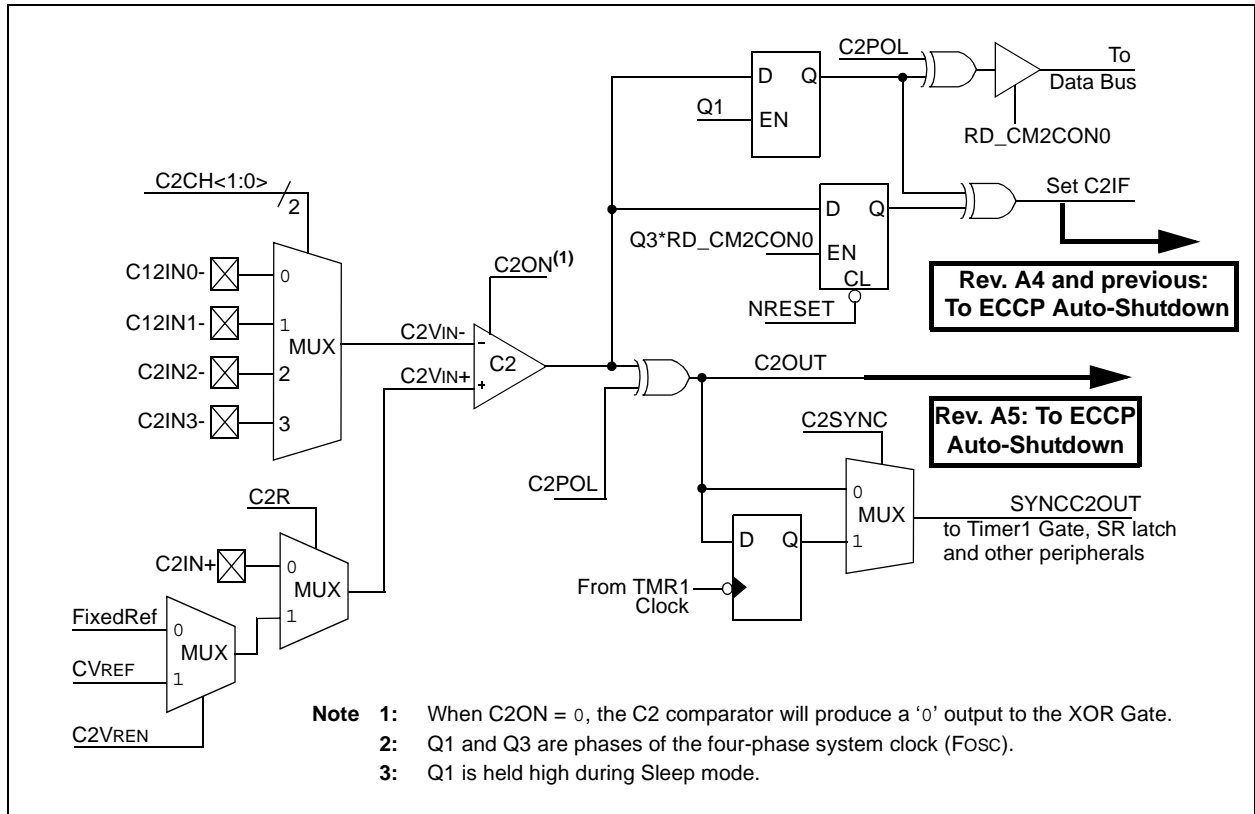
The Silicon Rev. A5 (now shipping) and later revision devices have moved the auto-shutdown connection from CxIF to CxOUT. This will eliminate the synchronous shutdown and simplify the use of the comparator for a shutdown event. Figure 1 shows the function of auto-shutdown before and after the device revision.

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**FIGURE 8-2: COMPARATOR C1 SIMPLIFIED BLOCK DIAGRAM**

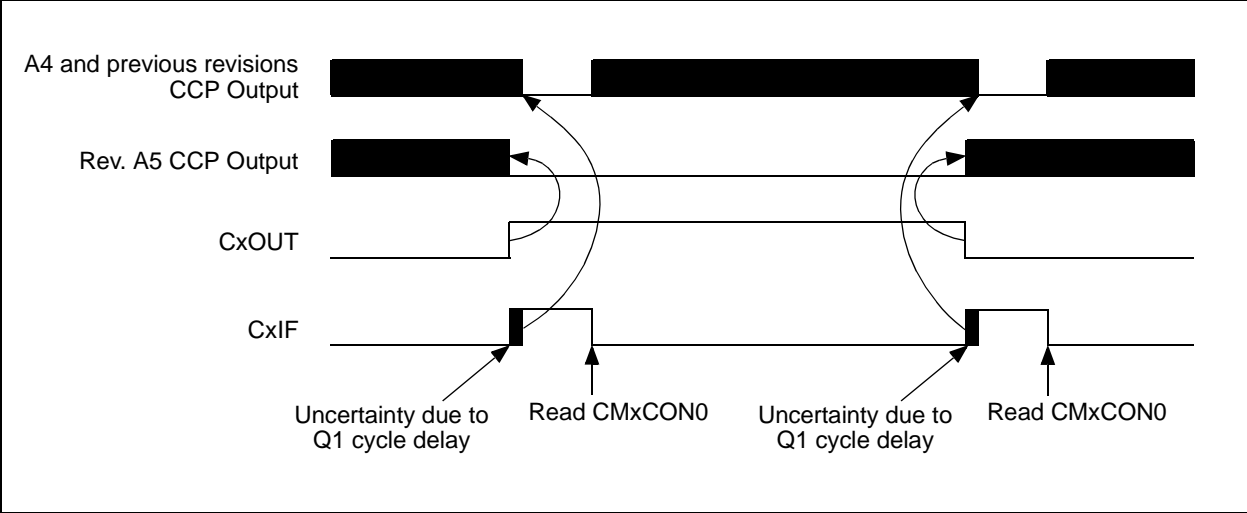


**FIGURE 8-3: COMPARATOR C2 SIMPLIFIED BLOCK DIAGRAM**



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FIGURE 1: SILICON REVISION A4 AND PREVIOUS VS. REVISION A5



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## Clarifications/Corrections to the Data Sheet:

In the Device Data Sheet (DS41262C), the following clarifications and corrections should be noted.

### 1. Module: 20-Pin QFN Pin Diagram Title

Change Title: **PIC16F690** Pin Diagram (QFN) to **PIC16F631/677/685/687/689/690** Pin Diagram (QFN), for the 20-pin QFN, on page 7.

### 2. Module: Product Identification System

Under "Examples", page 291:

Change from:

c) PIC16F690T - T/E/SS

To:

c) PIC16F690T - E/SS

### 3. Module: Comparator and Voltage Reference Modules Associated Registers

Remove REFCON row from Table 8-2: "Summary of Registers Associated with the Comparator and Voltage Reference Module" as it is not applicable.

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## 4. Module: DC Characteristics

In Table 17.3, Parameters D020E through D026E, change Max values as shown in bold.

### 17.3 PIC16F631/677/685/687/689/690-E (Extended)

DC CHARACTERISTICS		Standard Operating Conditions (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$ for extended					
Param No.	Device Characteristics	Min	Typ†	Max	Units	Conditions	
						VDD	Note
D020E	Power-down Base Current(I <sub>PD</sub> ) <sup>(2)</sup>	—	0.15	<b>9</b>	μA	2.0	WDT, BOR, Comparators, VREF and T1OSC disabled
		—	0.20	<b>11</b>	μA	3.0	
		—	0.35	<b>15</b>	μA	5.0	
		—	90	500	nA	3.0	$-40^{\circ}\text{C} \leq T_A \leq +25^{\circ}\text{C}$
D021E		—	1.0	<b>17.5</b>	μA	2.0	WDT Current <sup>(1)</sup>
		—	2.0	<b>19</b>	μA	3.0	
		—	3.0	<b>22</b>	μA	5.0	
D022E		—	42	<b>65</b>	μA	3.0	BOR Current <sup>(1)</sup>
		—	85	<b>127</b>	μA	5.0	
D023E		—	32	45	μA	2.0	Comparator Current <sup>(1)</sup> , both comparators enabled
		—	60	78	μA	3.0	
		—	120	160	μA	5.0	
D024E		—	30	<b>70</b>	μA	2.0	CVREF Current <sup>(1)</sup> (high range)
		—	45	<b>90</b>	μA	3.0	
		—	75	<b>120</b>	μA	5.0	
D024AE*		—	39	<b>91</b>	μA	2.0	CVREF Current <sup>(1)</sup> (low range)
		—	59	<b>117</b>	μA	3.0	
		—	98	<b>156</b>	μA	5.0	
D025E		—	4.0	TBD	μA	2.0	T1OSC Current
		—	4.6	TBD	μA	3.0	
		—	6.0	TBD	μA	5.0	
D026E		—	0.30	<b>12</b>	μA	3.0	A/D Current <sup>(1)</sup> , no conversion in progress
		—	0.36	<b>16</b>	μA	5.0	
D027E		—	TBD	TBD	μA	3.0	VP6 Current
		—	TBD	TBD	μA	5.0	

**Legend:** TBD = To Be Determined

† Data in "Typ" column is at 5.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

- Note** 1: The test conditions for all I<sub>DD</sub> measurements in Active Operation mode are: OSC1 = external square wave, from rail-to-rail; all I/O pins tri-stated, pulled to V<sub>DD</sub>; MCLR = V<sub>DD</sub>; WDT disabled.
- 2: The supply current is mainly a function of the operating voltage and frequency. Other factors, such as I/O pin loading and switching rate, oscillator type, internal code execution pattern and temperature, also have an impact on the current consumption.
- 3: For RC oscillator configurations, current through R<sub>EXT</sub> is not included. The current through the resistor can be extended by the formula  $I_R = V_{DD}/2R_{EXT}$  (mA) with R<sub>EXT</sub> in kΩ.
- 4: The peripheral current is the sum of the base I<sub>DD</sub> or I<sub>PD</sub> and the additional current consumed when this peripheral is enabled. The peripheral Δ current can be determined by subtracting the base I<sub>DD</sub> or I<sub>PD</sub> current from this limit. Max values should be used when calculating total current consumption.
- 5: The power-down current in Sleep mode does not depend on the oscillator type. Power-down current is measured with the part in Sleep mode, with all I/O pins in high-impedance state and tied to V<sub>DD</sub>.

## REVISION HISTORY

### Rev A Document (7/2005)

Original release of this document.

Clarifications/Corrections to the Data Sheet:

Added Modules 1 through 7:

Module 1: Device V<sub>DD</sub> Range

Module 2: 4x4 QFN Package Marking

Module 3: Table 1-1: Pinout Description – PIC16F685

Module 4: Register 10-5: EECON1

Module 5: Table 11-2: Registers Associated with  
Capture, Compare and Timer1

Module 6: Section 12.0 EUSART

Module 7: Section 14.2.2 MCLR

### Rev B Document (8/2005)

Silicon Section:

Added Module 1: EUSART (PIC16F687/689/690 only).

Clarifications/Corrections to the Data Sheet:

Added Modules 8 and 9:

Module 8: SSP Module Overview

Module 9: Electrical Specifications.

### Rev C Document (11/2005)

Silicon Section:

Added Module 2: SSP (PIC16F687/689/690 only)

### Rev D Document (01/2006)

Clarifications/Corrections to the Data Sheet:

Replaced the 20-Lead QFN package diagram in  
Module 2: 4x4 QFN Package Marking.

### Rev E Document (7/2006)

Data Sheet Clarifications/Corrections Section:  
Removed Items 1 through 9, which have been  
incorporated into the data sheet. Added Item 1, 20-pin  
QFN Pin Diagram Title change.

### Rev F Document (11/2006)

Data Sheet Clarifications/Corrections Section: Added  
Item 2, Product Identification System, Examples  
change.

Added Module 3: ECCP with Auto-Shutdown (Silicon  
Rev. B2). Updated Module1: EUSART (PIC16F687/  
689/690 only) and Module2: SSP (PIC16F687/689/690  
only) with Fix information.

### Rev G Document (01/2007)

Removed Rev. A6 reference from Module 2 (SSP).

Data Sheet Clarifications/Corrections Section: Added  
Module 3, Comparator and Voltage Reference Modules  
Associated Registers, removed REFCON register  
reference. Added Module 4: DC Characteristics, Table  
17.3, revised Max values.

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NOTES:



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